



SMD Comm X7R, Ceramic, 6,800 pF, 5%, 250 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 1206, 1.5 mm



General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	17 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm
-	

10000

Packaging Quantity

W	1.6mm +/-0.2mm	Tolerance
Т	0.78mm +/-0.10mm	Voltage DC
S	1.5mm MIN	Dielectric Withstanding Volt
В	0.5mm +/-0.25mm	Temperature Range
		Temp. Coefficient
Packaging Specifications		Capacitance Change with
Packaging	T&R, 330mm, Plastic Tape	Reference to +25°C and 0 V

Specifications	
Capacitance	6,800 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0 Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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